PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6211705

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date
VINAY MELKOTE KRISHNAPRASAD	06/30/2020
AJIT VENKAT RAO	04/21/2020
THOMAS STOCKHAMMER	04/20/2020

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED	
Street Address:	5775 MOREHOUSE DRIVE	
City:	SAN DIEGO	
State/Country:	CALIFORNIA	
Postal Code:	92121-1714	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16741554

CORRESPONDENCE DATA

Fax Number: (202)857-6395

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 213-629-7400

Email: patentdocket@arentfox.com, rachele.wittwer@arentfox.com

Correspondent Name: ARENT FOX, LLP AND QUALCOMM, INCORPORATED

Address Line 1: 1717 K STREET, NW

Address Line 4: WASHINGTON, D.C. 20006-5344

ATTORNEY DOCKET NUMBER:	030284.17789/191226	
NAME OF SUBMITTER:	RACHELE WITTWER	
SIGNATURE:	/Rachele Wittwer/	
DATE SIGNED:	07/21/2020	

Total Attachments: 6

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PATENT 506164969 REEL: 053272 FRAME: 0404

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ASSIGNMENT

WHEREAS, WE,

- 1. Vinay MELKOTE KRISHNAPRASAD, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,
- 2. Ajit Venkat RAO, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,
- 3. Thomas STOCKHAMMER, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **METHODS AND APPARATUS FOR STANDARDIZED APIS FOR SPLIT RENDERING** (collectively the "**INVENTIONS**") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 16/741,554 filed January 13, 2020, Qualcomm Reference Number 191226, and all provisional applications relating thereto, together with India Provisional Application No(s). 201941002809, filed January 23, 2019, Qualcomm Reference Number 191226IN1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International

Convenients. Treaties or Agreements and the entire right, title and interest throughout the world in said INVENTIONS, including all inventions related thereof or the soil INVENTIONS applications applications applications in any barriers country, countries or pearly/union organizations, and all divisions applications resewal applications. Continuation in part applications, patent of addition applications, continuation in part applications, patent of addition applications, continuation applications, units, model applications, and design applications thereof, and all issued patents which may have granted or new be granted hereafter for and INVENTIONS in any country or countries foreign to the limited States, and all resistes, renewals, reexaminations, and extensions thereof.

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIONEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any origoning or prospective royalities to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance.

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or eaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns to obtain and enforce patent protection for said INVENTIONS in all countries.

AND WE HEREBY with the service of th	coverant that WE store presents	will not execute any	writing or do any acre
Done of <u>Early 1884</u> Ted 49	N.	o Chipay	W.
City, State	Date	Vinly MELKOTE	KRISHNAFRASAD
Done at, o	n		
City State	Date	Ajit Venkat RAO	
Done at			
City, State	0 - 1344	Thomas STOCKS	AMMER

ASSIGNMENT

WHEREAS, WE,

- 1. Vinay MELKOTE KRISHNAPRASAD, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,
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WHEREAS, **QUALCOMM Incorporated** (hereinafter "**ASSIGNEE**"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No(s). 16/741,554 filed January 13, 2020, Qualcomm Reference Number 191226, and all provisional applications relating thereto, together with India Provisional Application No(s). 201941002809, filed January 23, 2019, Qualcomm Reference Number 191226IN1, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International

PATENT Qualcomm Reference Number, 191226 Page 2 of 2

Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof.

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalities to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance.

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at		, on		6.6
	Crty, State		Date	Vinay MELKOTE KRISHNAPRASAL
Done at	Bangalore	India	21-Apr-2020	
	City, State		Date	Ajit Venkat RAO
Done at	4	, on		
	City, State:		Date	Thomas STOCKHAMMER

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Done at	, on		
· *	City, State	Date	Vinay MELKOTE KRISHNAPRASAD
Done at		.on	
	City, State	Date	Ajit Venkat RAO
	·	A.	
Done at _	Rogar	_, on 101 20,	20 165/
	Ohy, State	Date	Thomas SIOCKHAMMER

PATENT REEL: 053272 FRAME: 0411

RECORDED: 07/21/2020